## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6283383

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
Shunpei Yamazaki	01/15/2015
Hideaki Shishido	01/16/2015

### **RECEIVING PARTY DATA**

Name:	SEMICONDUCTOR ENERGY LABORATORY CO., LTD.	
Street Address:	398, HASE	
City:	ATSUGI-SHI, KANAGAWA-KEN	
State/Country:	JAPAN	
Postal Code:	243-0036	

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	17011486

### CORRESPONDENCE DATA

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**ATTORNEY DOCKET NUMBER:** 12732-1417004 NAME OF SUBMITTER: SHARON M. ALLEN SIGNATURE: /Sharon M. Allen/ **DATE SIGNED:** 09/03/2020

**Total Attachments: 1** 

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**PATENT REEL: 053689 FRAME: 0789** 

# **ASSIGNMENT**

For valuable consideration, We, <u>Shunpei YAMAZAKI of Setagaya</u>, <u>Tokyo</u>, <u>Japan and Hideaki SHISHIDO of Atsugi</u>, <u>Kanagawa</u>, <u>Japan</u> hereby assign to <u>Semiconductor Energy Laboratory Co.</u>, <u>Ltd.</u>, a <u>Japanese</u> corporation having a place of business at:

398, Hase, Atsugi-shi, Kanagawa-ken, 243-0036 Japan

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title and interest throughout the world in the inventions and improvements which are subject of an application for United States Patent signed by us this day, entitled <a href="ELECTRONIC DEVICE">ELECTRONIC DEVICE</a>, filed <a href="D2/09/2015">D2/09/2015</a>, and assigned U.S. Serial Number <a href="L14/616">L14/616</a>, 827</a>, and we authorize and request the attorneys appointed in said application to hereafter complete this assignment by inserting above the filing date and serial number of said application when known; this assignment including said application, any and all United States and foreign patents, utility models, and design registrations granted for any of said inventions or improvements, and the right to claim priority based on the filing date of said application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and we authorize the Assignee to apply in all countries in our name or in its own name for patents, utility models, design registrations and like rights of exclusion and for inventors' certificates for said inventions and improvements; and we agree for ourselves and our respective heirs, legal representatives and assigns, without further compensation to perform such lawful acts and to sign such further applications, assignments, Preliminary Statements and other lawful documents as the Assignee may reasonably request to effectuate fully this assignment.

Signature

Name: Date:

01/15/2015

Signature

Hideaki SHISHIDO

Name:

Hideaki SHISHIDO

RECORDED: 09/03/2020

Date:

01/16/2015

PATENT REEL: 053689 FRAME: 0790